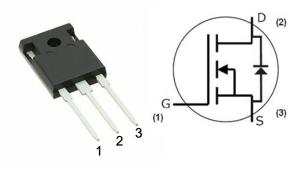


Product Summary

 $V_{DS} = 1200 \text{ V}$ $I_{D} @ 25^{\circ}\text{C} = 64\text{A}$ $R_{DS(ON)} = 36\text{m}\Omega$





TO-247-3

Features

- High Blocking Voltage
- High Frequency Operation
- Low on-resistance
- Fast intrinsic diode with low reverse recovery

Applications

- Motor Drives
- Solar / Wind Inverters
- EV Charging Station

Benefits

- Higher System Efficiency
- Parallel Device Convenience without thermal runaway
- High Temperature Application
- Hard Switching & Higher Reliability
- · Easy to drive
- AC/DC converters
- DC/DC converters
- Uninterruptable power supplies

Maximum Ratings (T_C=25°C unless otherwise specified)

Parameter	Symbol	Test conditions	Value	Unit
Drain - Source Voltage	V_{DSmax}	V_{GS} =0V, I_D =100 μ A	1200	V
Gate - Source Voltage (dynamic)	V_{GSmax}	AC (f>1 Hz)	-10 / +25	V
Gate - Source Voltage (static)	V_{GSop}	static	-5 / +20	V
Continuous Drain Current	I_D	V _{GS} = 20V, T _C =25°C	64	Α
		V _{GS} = 20V, T _C =100°C	45	
Pulsed Drain Current	I _{D(pulse)}	Tc=25°C	112	Α
Short Circuit Capability	t _{sc}	V _{DD} =800V, V _{GS} =20V	3.5	μS
Short Circuit Capability	I _{DS}	V _{DD} =800V, V _{GS} =20V	500	Α
Total power dissipation	P_{D}	T _C =25°C	300	W
Operating Junction Temperature	T_J		-55 to 175	°C
Storage Temperature	T _{STG}		-55 to 175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



Electrical Characteristics (T_C=25°C unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Тур	Max	Unit	
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0V, I_{D} = 100\mu A$	1200			V	
		$V_{DS} = V_{GS}$, $I_D = 10mA$	1.8	2.8	3.9	V	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 10 \text{mA},$ $T_{J} = 150 ^{\circ} \text{C}$		1.9			
Ç .		$V_{DS} = V_{GS}, I_{D} = 10 \text{mA},$ $T_{J} = 175^{\circ}\text{C}$		1.8		V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 1200V, V _{GS} = 0V	0	5	100	μΑ	
Gate-Source Leakage Current	I_{GSS}	$V_{GS} = 20V, V_{DS} = 0V$	0	10	200	nA	
Gate-Source Leakage Current	I _{GSS}	$V_{GS} = -5V, V_{DS} = 0V$	-200	-10	0	nA	
		$V_{GS} = 18V, I_D = 40 A$		41			
	R _{DS(on)}	$V_{GS} = 18V, I_D = 40 A,$ $T_J = 150^{\circ}C$		61			
Drain-Source On-State		$V_{GS} = 18V, I_D = 40 A,$ $T_J = 175^{\circ}C$		68			
Resistance		$V_{GS} = 20V, I_D = 40 A$		36	50	mΩ	
		$V_{GS} = 20V, I_D = 40 A,$ $T_J = 150^{\circ}C$		58			
		V _{GS} = 20V, I _D = 40 A, T _J = 175°C		65			
Transconductance	g fs	$V_{DS} = 20V, I_D = 40 A,$		23			
		$V_{DS} = 20V, I_{D} = 40 A,$ $T_{J} = 150^{\circ}C$		20		S	
Transconductance		$V_{DS} = 20V, I_D = 40 A,$ $T_J = 175^{\circ}C$		20			
Input capacitance	C _{iss}			2980			
Output capacitance	Coss	$V_{DS} = 1000V, V_{GS} = 0V$		143		pF	
Reverse transfer capacitance	C _{rss}	f = 1MHz		15			
Coss Stored Energy	E _{oss}			92		μJ	
Total gate charge	Q_{g}	V _{DS} = 800V, V _{GS} = -5V / 20V		146			
Gate-source charge	Q_{gs}	$I_D = 40 \text{ A},$		44		nC	
Gate-drain charge	Q_gd	ID - 40 A,		74		7	
Internal gate input resistance	R _{g(int)}	$f = 1MHz, I_D = 0A$		2		Ω	
Turn-On Switching Energy	Eon			965			
Turn-Off Switching Energy	E _{OFF}	$V_{DS} = 800 \text{ V}, V_{GS} = -5\text{V}/20\text{V}, V_{GS} = -5\text{V}/20\text{V}, V_{DS} = 40\text{A}, R_{G(ext)} = 4\Omega, V_{DS} = 4000 \text{ L} = 200 \text{ m}$		110		μJ	
Turn-On Delay Time	t _{d(on)}			16		ns	
Rise Time	t _r			44			
Turn-Off Delay Time	$t_{d(off)}$	ι-2υυμπ		33			
Fall Time	Ì _f			10			
Avalanche Capability	E _{AS}	V _{DD} = 100V, V _{GS} =20V, L=2mH		400		mJ	
Avalanche Capability	I _{AV}	$V_{DD} = 100V, V_{GS} = 20V, L = 2mH$		20		Α	







Reverse Diode Characteristics (T_C=25°C unless otherwise specified)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Diode Forward Voltage		$V_{GS} = -5V, I_{SD} = 20A,$		3.9		
ğ.		$V_{GS} = -5V$, $I_{SD} = 20A$,		3.7		
	V_{SD}	V_{SD} $T_J = 150$ °C		5.1		V
		$V_{GS} = -5V$, $I_{SD} = 20A$,		3.6		
		T _J = 175°C		0.0		
Continuous Diode Forward	Is	$V_{GS} = -5V$		60		Α
Current	13	VG3				
Reverse Recovery time	t_{rr}			17		ns
Reverse Recovery Charge	Q_{rr}	$V_{GS} = -5V$, $I_{SD} = 40A$,		310		nC
Peak Reverse Recovery		V_R = 800V, dif/dt = 4200 A/ μ s		30		Α
Current	Irrm			50		

Thermal Characteristics

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Thermal Resistance (per device)	R _{th(j-c)}	junction-case		0.4	0.5	°C/W



Typical Performance

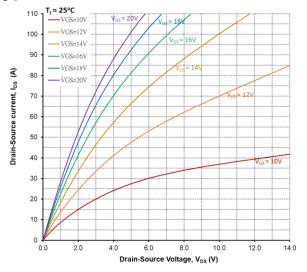


Figure 1. Output Characteristics, T_J = 25°C

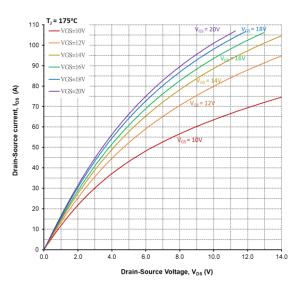


Figure 2. Output Characteristics, T_J = 175°C

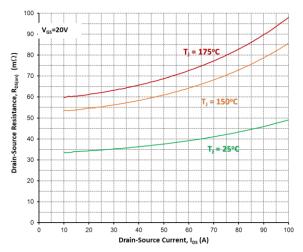


Figure 3. On-Resistance vs. Drain Current For Various Temperatures

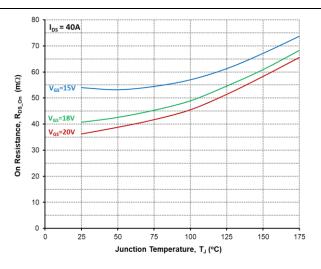


Figure 4. On-Resistance vs. Temperature

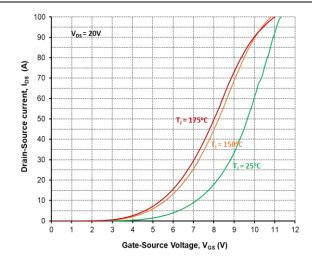


Figure 5. Transfer Characteristic For Various Junction Temperatures

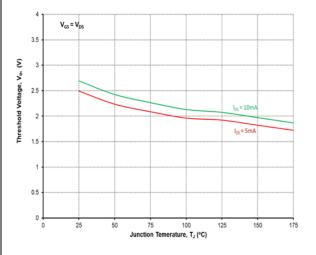


Figure 6. Threshold Voltage vs. Temperature

Revision 1.0 **PRELIMINARY** P.4 of 8



Typical Performance

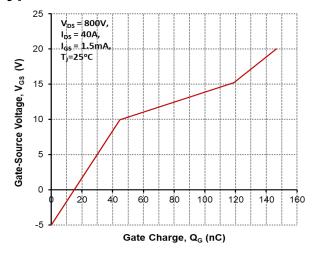


Figure 7. Gate Charge Characteristics

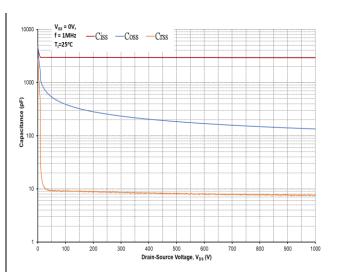


Figure 8. Capacitances vs. Drain-Source Voltage (0-1000V)

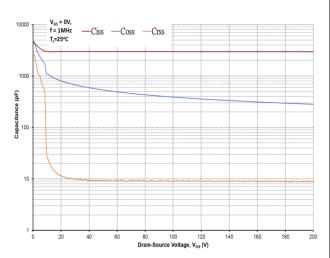


Figure 9. Capacitances vs. Drain-Source Voltage (0-200V)

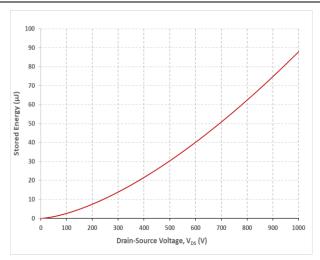


Figure 10. Output Capacitor Stored Energy

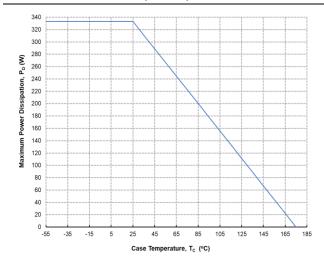


Figure 11. Maximum Power Dissipation Derating vs.

Case Temperature

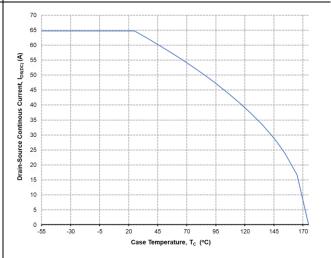


Figure 12. Continuous Drain Current Derating vs. Case Temperature



Typical Performance

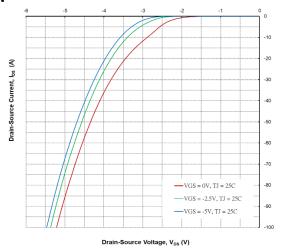


Figure 13. Body Diode Characteristics @ 25°C

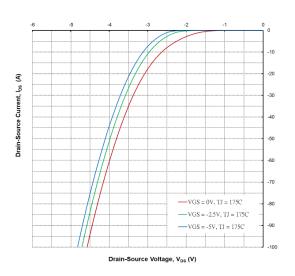


Figure 14. Body Diode Characteristics @ 175°C

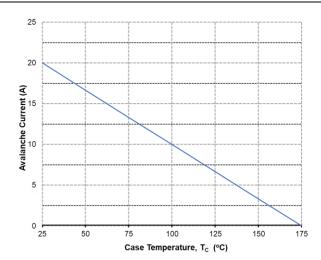


Figure 15. Single Avalanche vs. Temperature

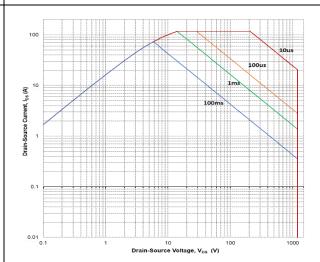
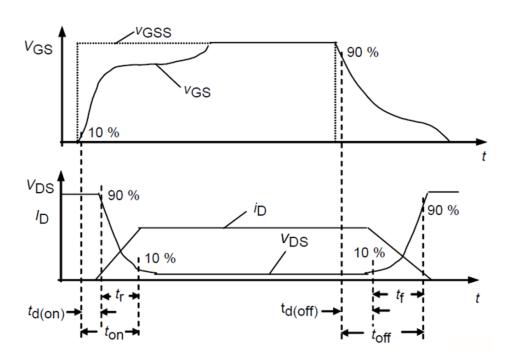
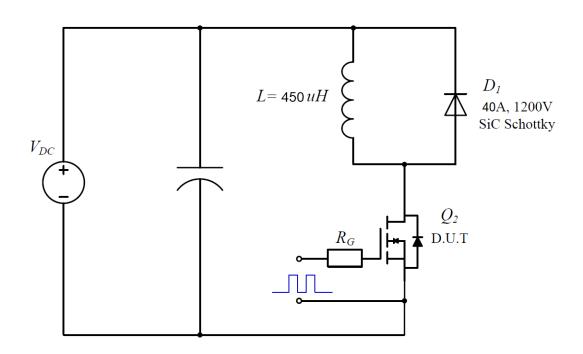


Figure 16. Safe Operating Area



Switching Times Definition and Test Circuit





Revision 1.0 **PRELIMINARY** P.7 of 8

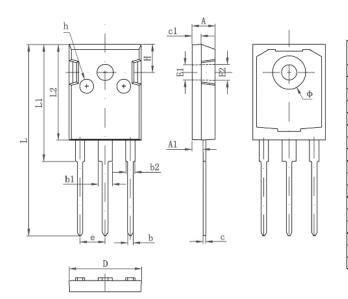






Package Dimensions

(TO-247-3 Package)



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α	4.850	5.150	0.191	0.200	
A1	2.200	2.600	0.087	0.102	
b	1.000	1.400	0.039	0.055	
b1	2.800	3.200	0.110	0.126	
b2	1.800	2.200	0.071	0.087	
С	0.500	0.700	0.020	0.028	
c1	1.900	2.100	0.075	0.083	
D	15.450	15.750	0.608	0.620	
E1	3.500 REF		0.138 REF		
E2	3.600 REF		0.142 REF		
L	40.900	41.300	1.610	1.626	
L1	24.800	25.100	0.976	0.988	
L2	20.300	20.600	0.799	0.811	
Ф	7.100	7.300	0.280	0.287	
е	5.450 TYP		0.215 TYP		
Н	5.980 REF		0.235 REF		
h	0.000	0.300	0.000	0.012	